

Ceramic Surface Mount TCXO

- * CMOS/TTL Output
- * Copped Sinewave Output
- * Fast Delivery

Applications

- * Communications
- * Routers
- * Switches
- * WAN Interfaces
- * Aerospace
- * Military/Space

Part Numbering Example: **CTAWCN5M - XX.XXXX M**

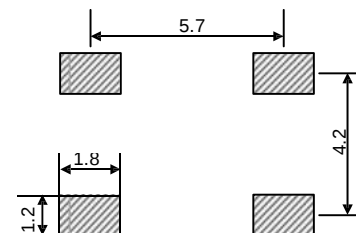
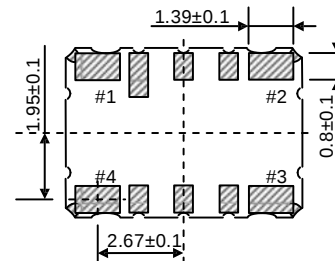
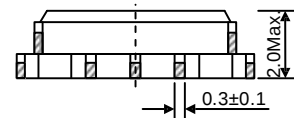
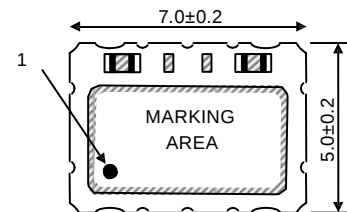
CTAW		C	N	5	M	22.5792M
SERIES	VOLTAGE	OUTPUT	OPERATING TEMP.	STABILITY	GRADE	FREQUENCY
	Blank = 5.0V I = 3.3V	T = TTL C = CMOS S = Cipped Sine	I = -30°C +75°C N = -40°C +85°C L = -55 °C +85 °C	5 = ±5.0 ppm 6 = ±3.0 ppm 7 = ±2.0 ppm 8 = ±1.0 ppm	I =Industrial Std M=MIL-STD-883B B=MILPFR-55310D	10 ~40,000 MHz

Specifications	Min	Typ	Max	Unit
Frequency Range:	10		40	MHz
Stability:				ppm
Supply Voltage:				V
Vdd Rise Time:	100			μS
Operating Temperature:				°C
Storage Temperature:	-55		125	°C
Duty Cycle:	45		55	%
Start-Up Time:		2		mS
Aging: (ppm/1st Year)			1	ppm
Supply Current:			35	mA
Short Circuit Current:		± 50		mA
RMS Period Jitter:		10		pS
RMS Integrated Jitter: 12kHz to 20MHz		15		pS
Phase Noise @ 10kHz:			-100	dBc/Hz
Output Voltage: Voh V _o		4.5 0.5		V
e: CL = 15 pf			2	μS

Tristate internal pull up. Output active when high.

Environmental And Mechanical	
Mechanical Shock	Per MIL-STD-883 ,Method 2002 ,Cond.B
Thermal Shock	Per MIL-STD-883 ,Method 1011 ,Cond.A
Vibration	Per MIL-STD-883 ,Method 2007 ,Cond.A
Seal	Per MIL-STD-883, Method 1014, Condition B & C
Solderability	Per MIL-STD-883 ,Method 2003 ,Cond.A

Dimensions are in mm



PIN FUNCTION
 1 CONTROL/ ND
 2 GND
 3 OUTPUT
 4 Vdd